

FIG. 1

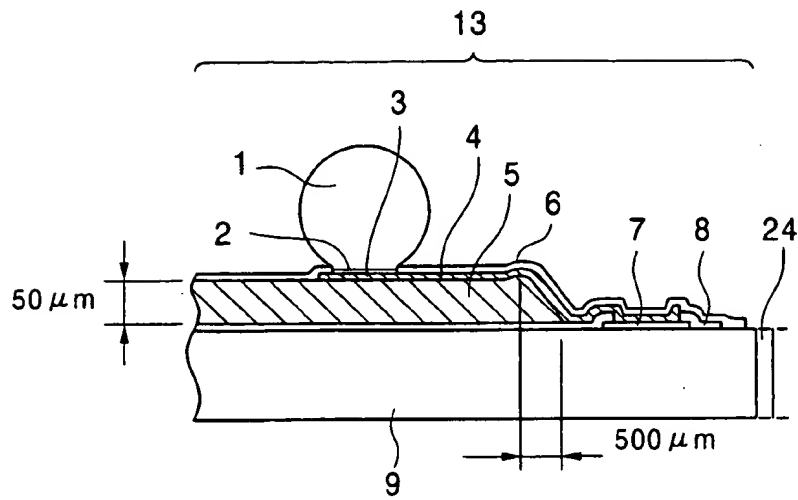


FIG. 2

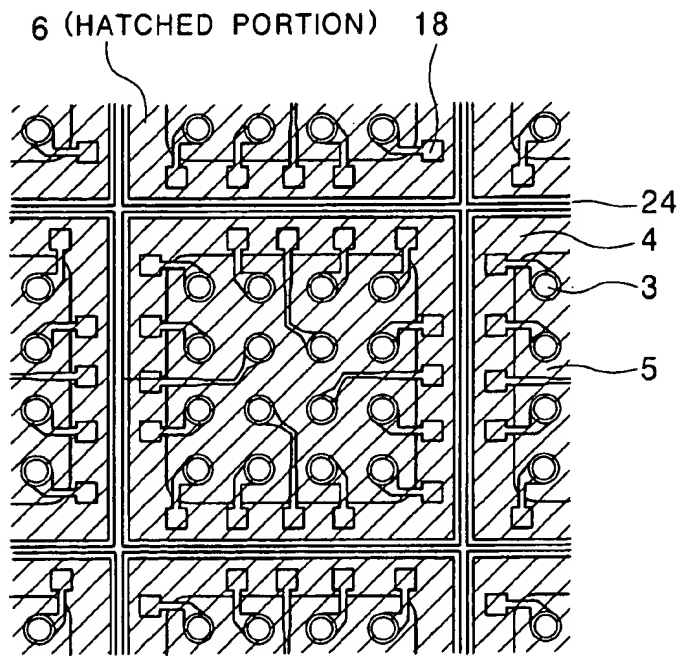
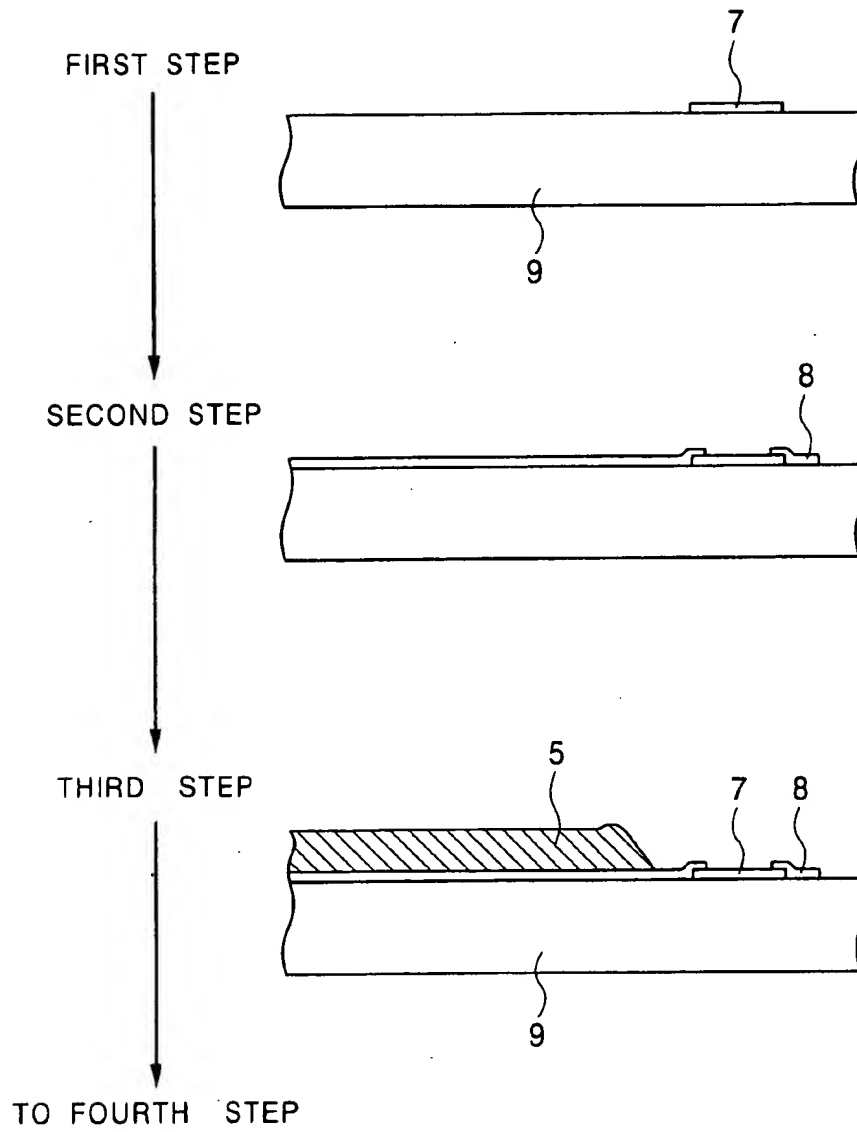


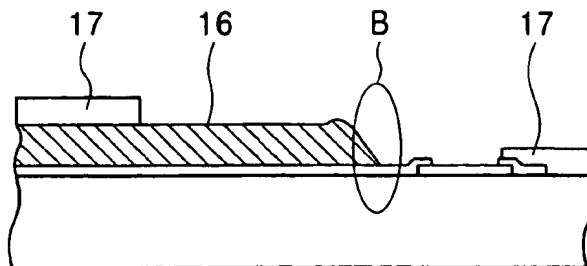
FIG. 3



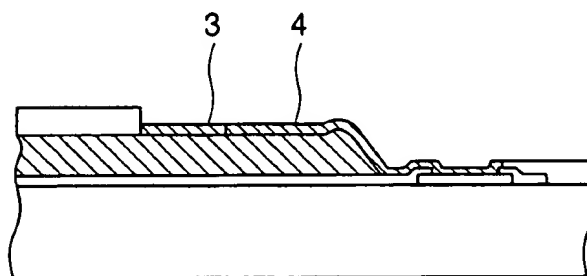
09698185-102000

FIG. 4

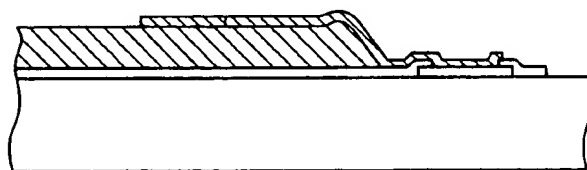
FOURTH STEP



FIFTH STEP



SIXTH STEP

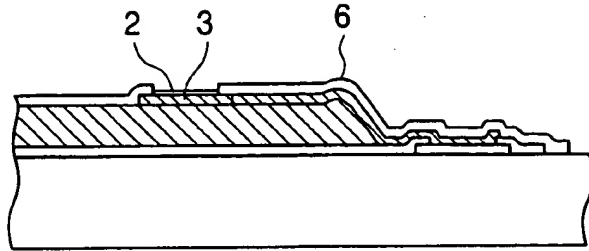


TO SEVENTH STEP

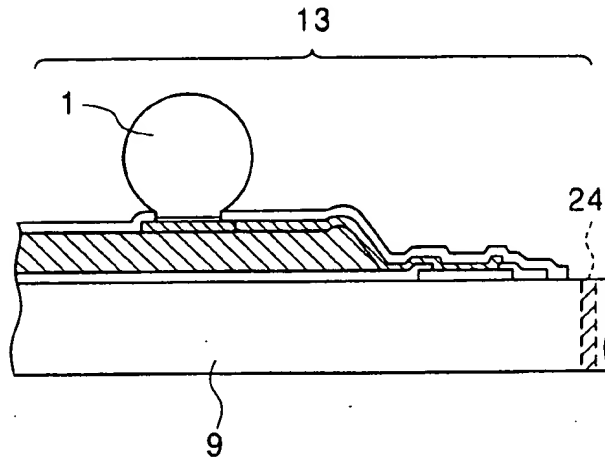
000001-58766560

FIG. 5

SEVENTH STEP



EIGHTH AND NINTH STEP



COMPLETE

000007 98186960

000207-98786960

FIG. 9

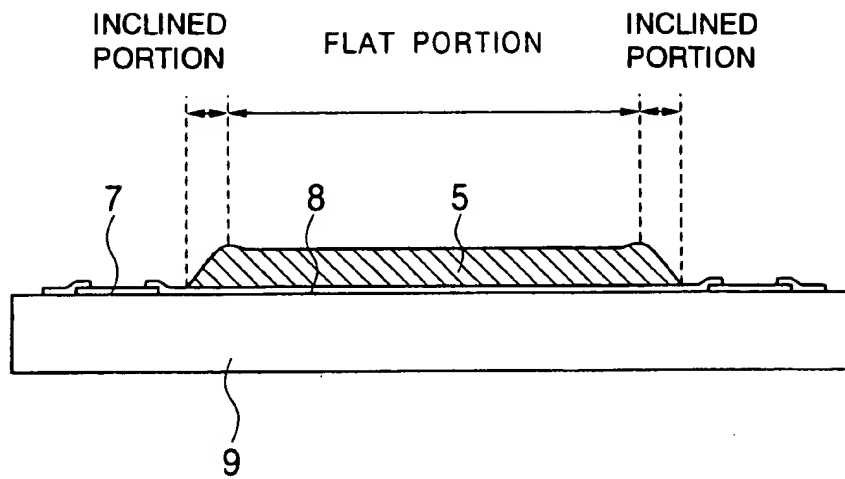


FIG. 10

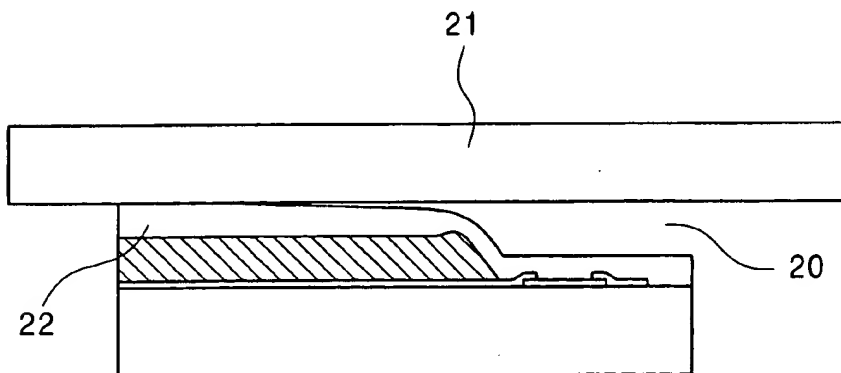


FIG. 11

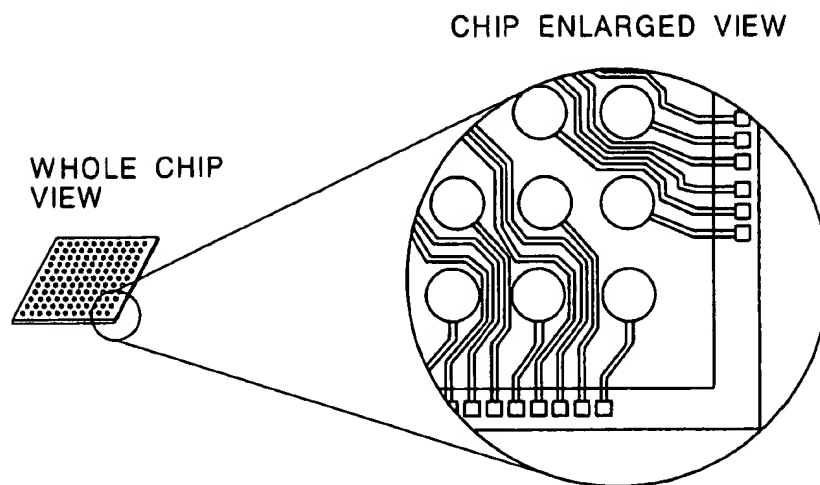


FIG. 12

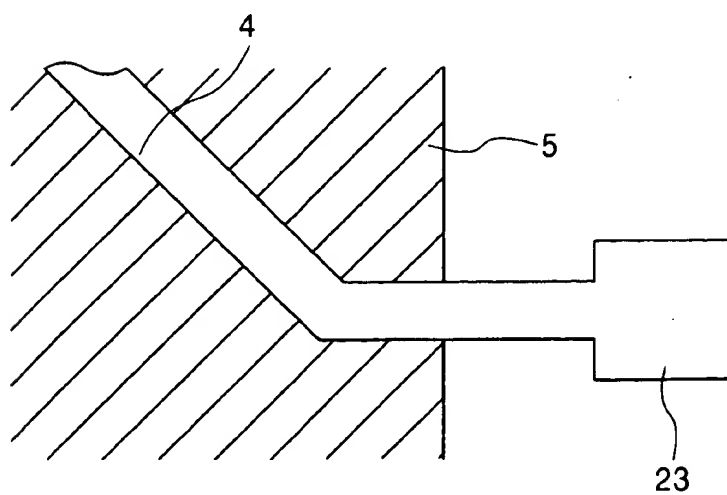


FIG. 13

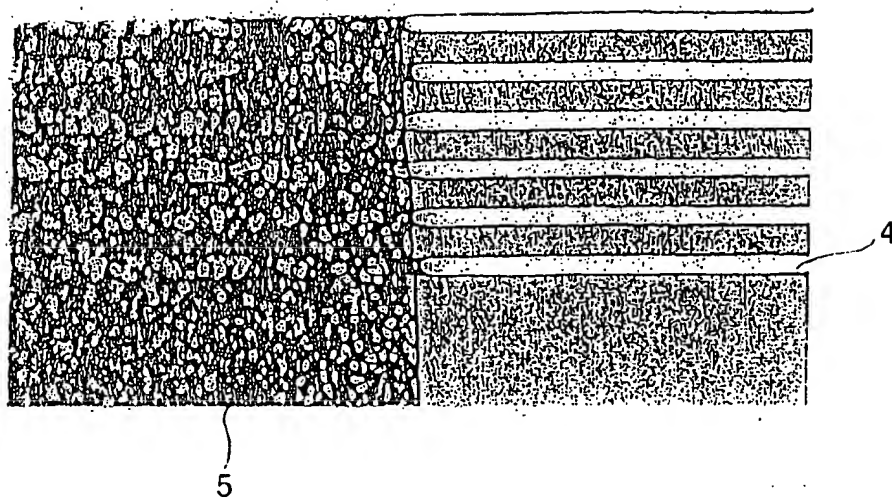


FIG. 14

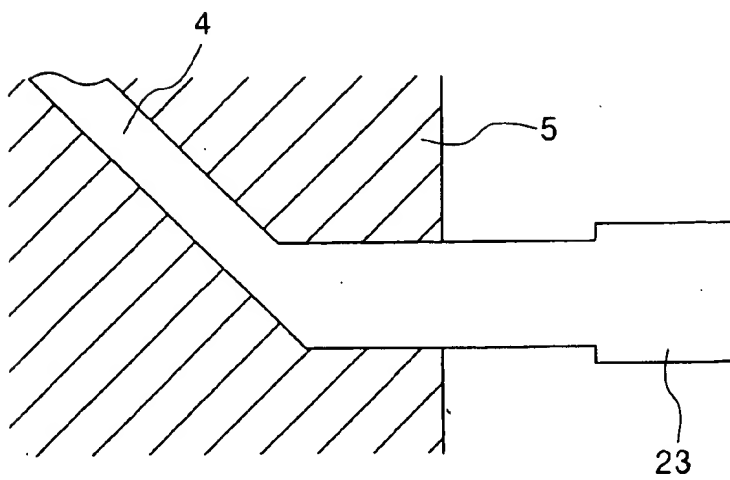
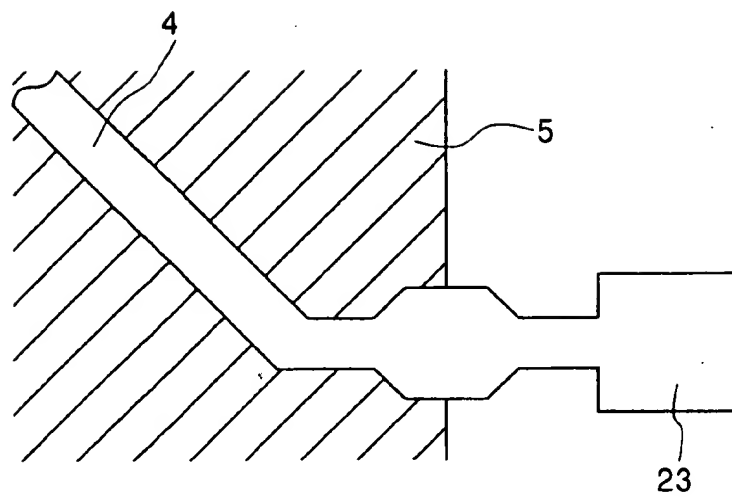


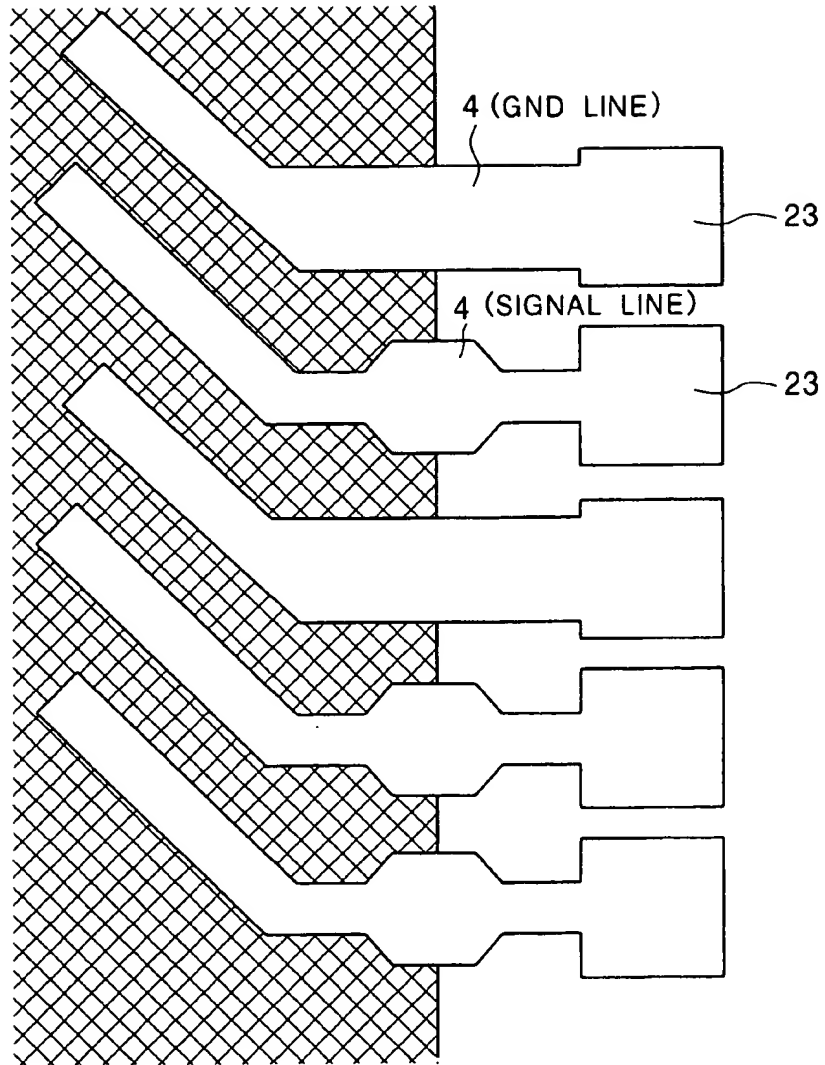
FIG. 15



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09598195-103000

FIG. 16



000001 98100900

FIG. 17

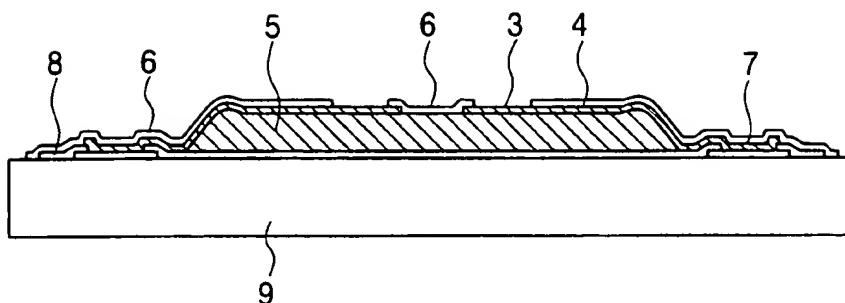
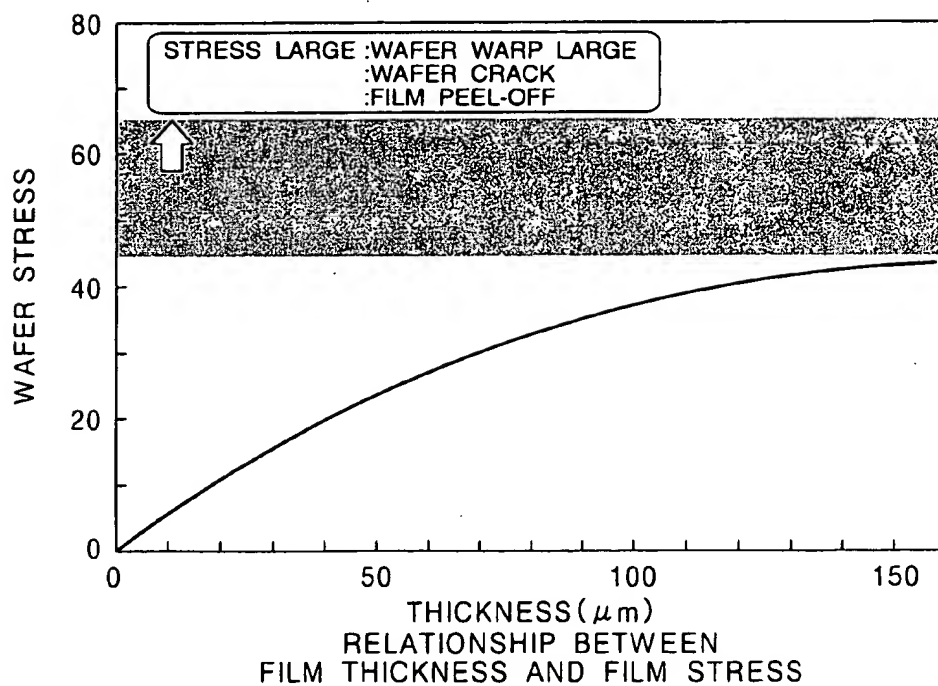
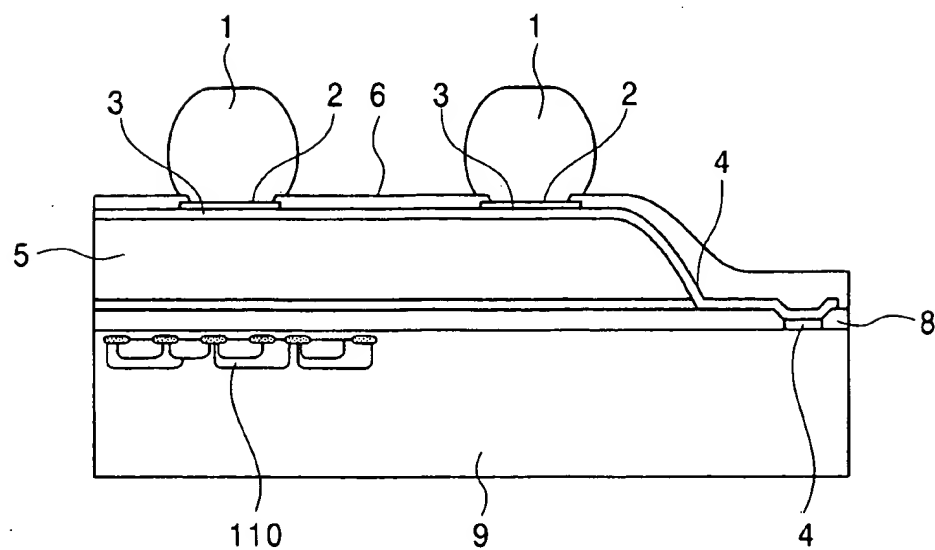


FIG. 18



[illegible]

FIG. 20



09599185 103000

FIG. 21

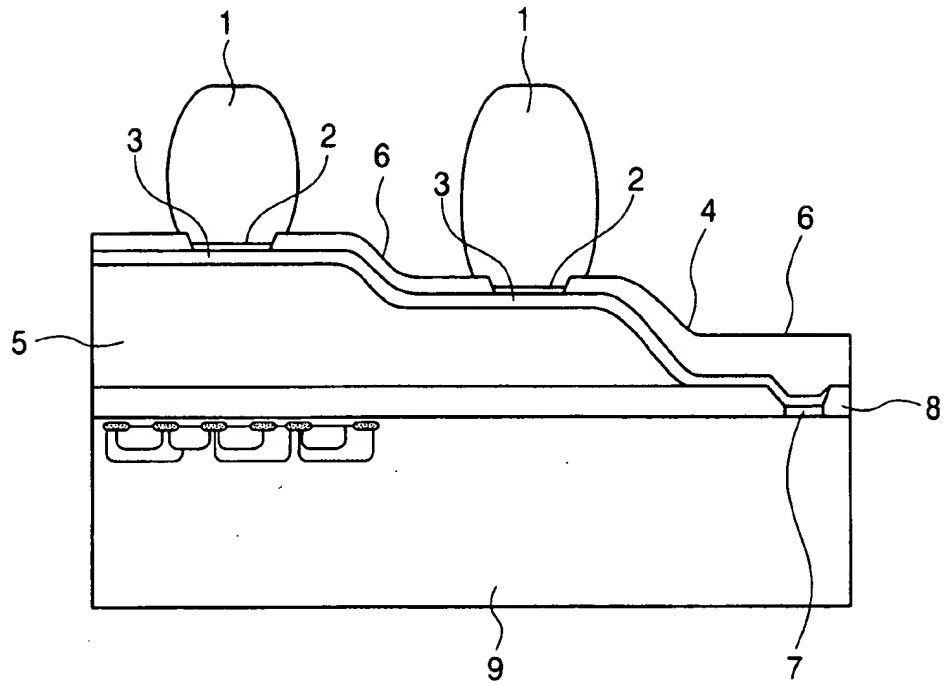


FIG. 22

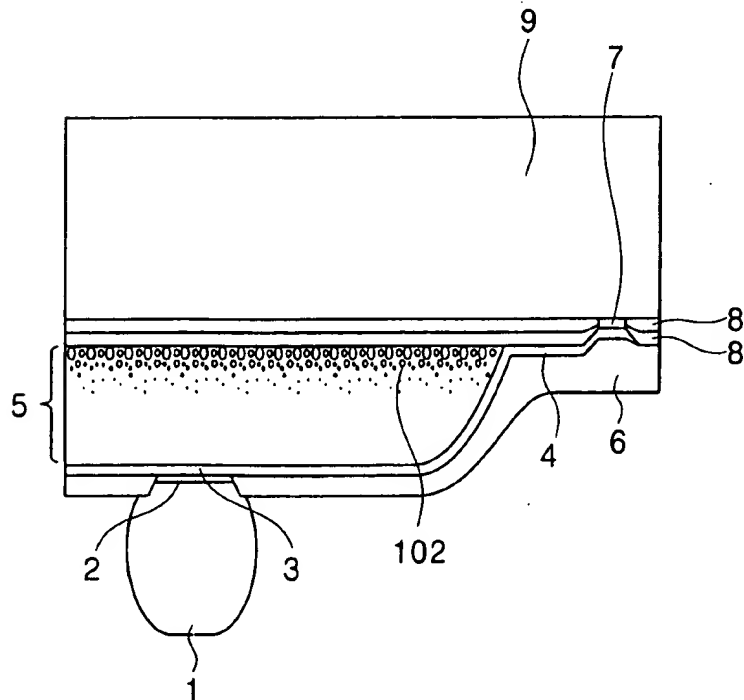


FIG. 23

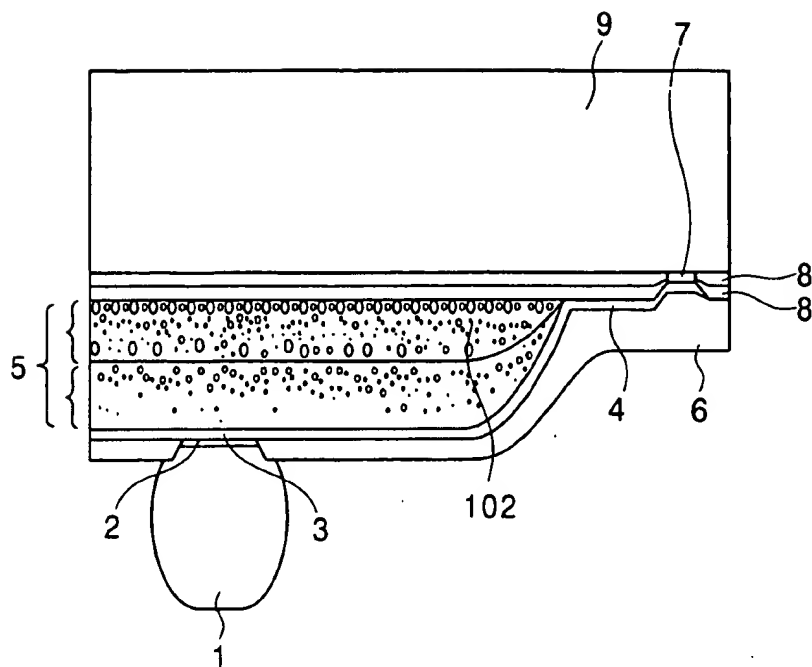


FIG. 24

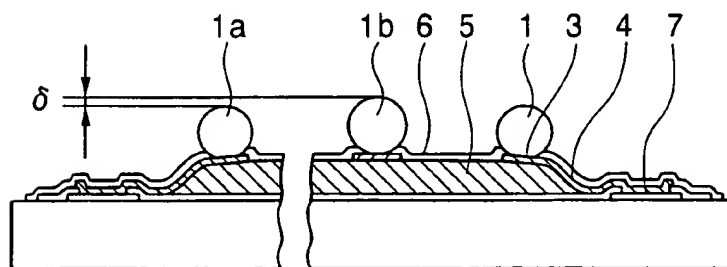


FIG. 25

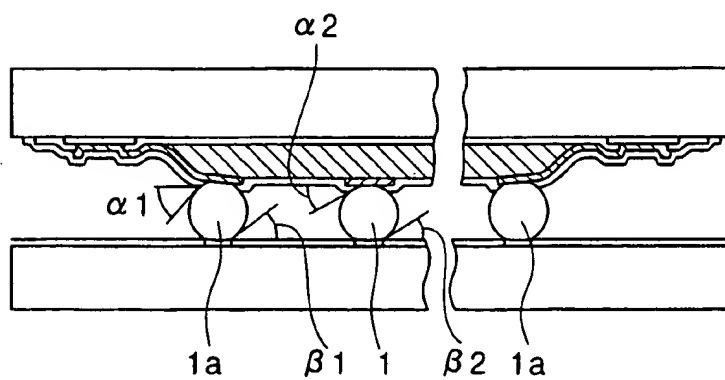


FIG. 26a

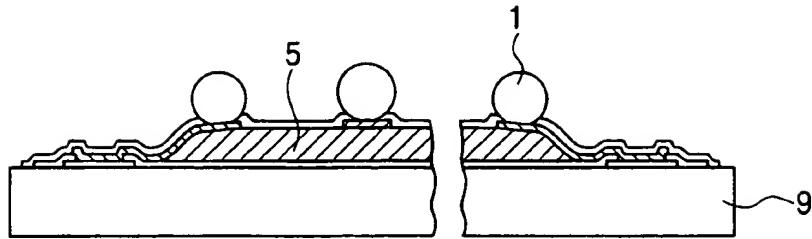


FIG. 26b

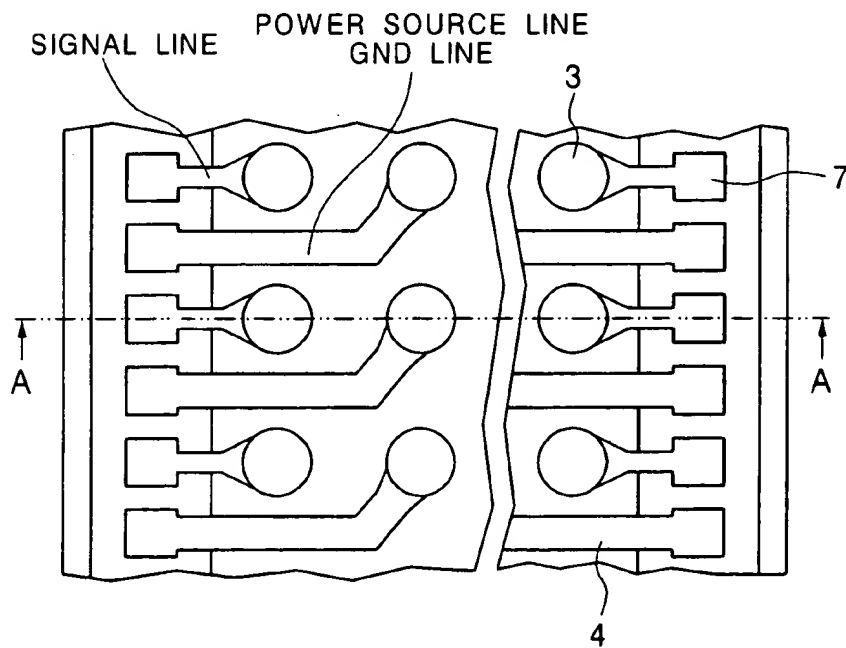
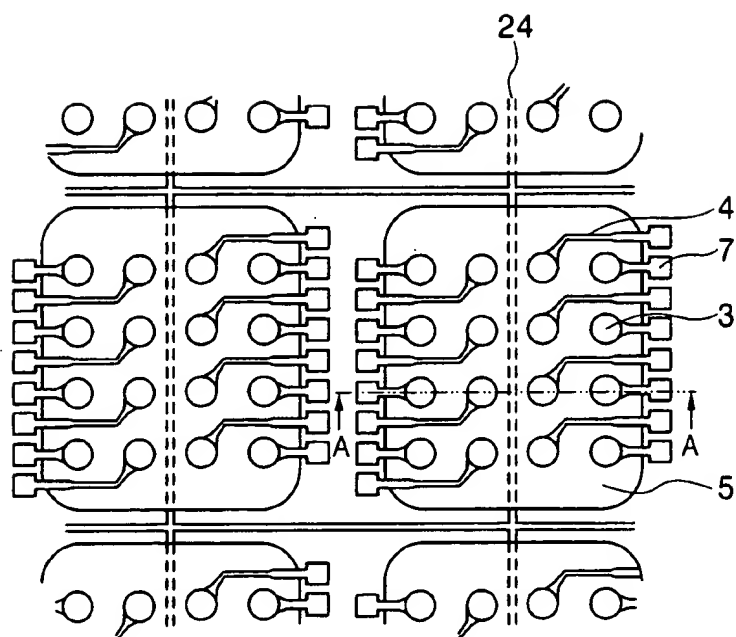
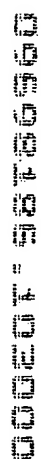


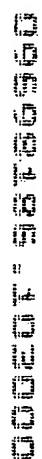
FIG. 27



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000207-56T66560

FIG. 31

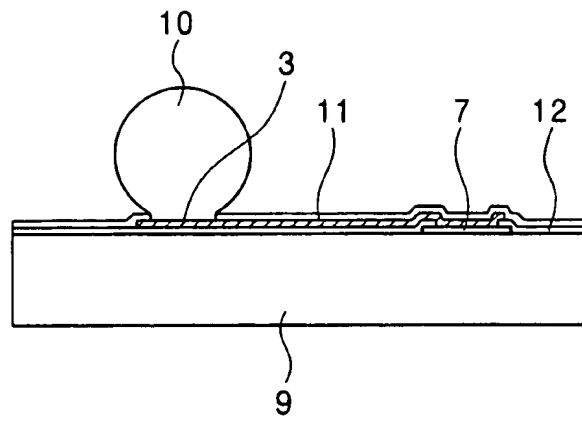


FIG. 32

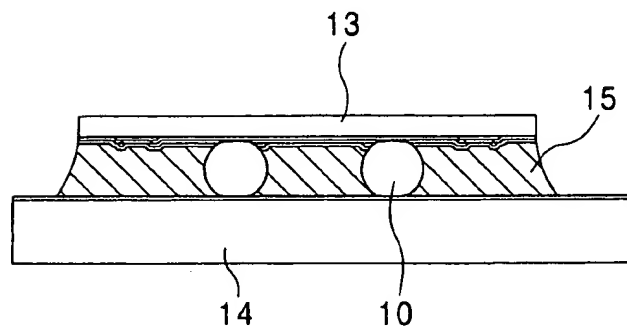


FIG. 33a

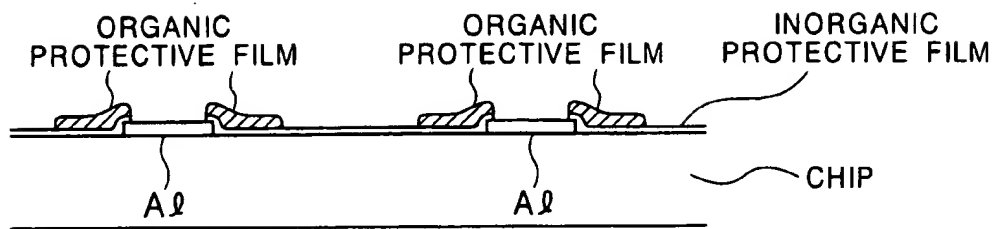
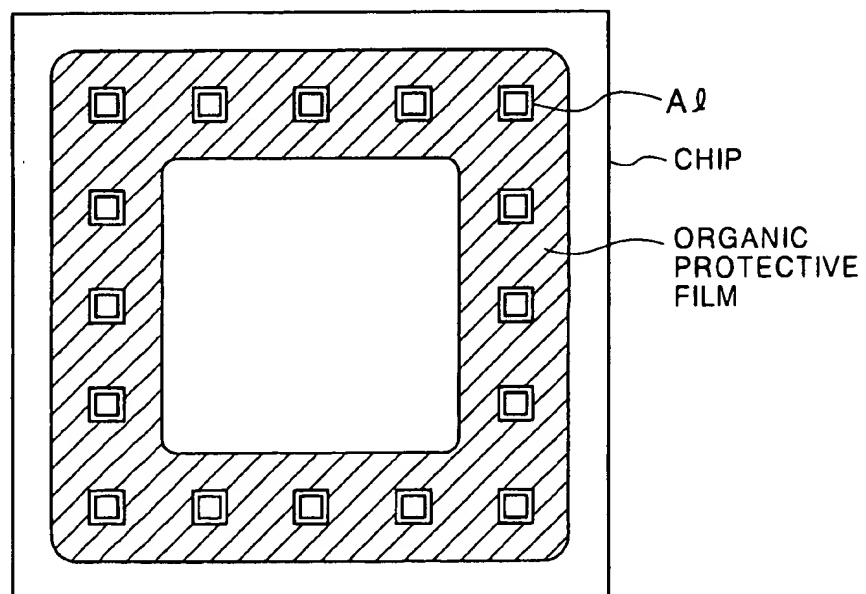


FIG. 33b



000007-96769560

FIG. 34a

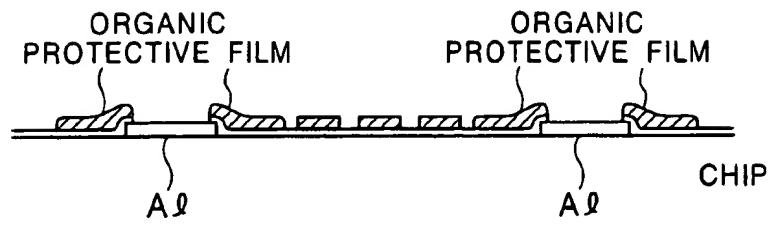


FIG. 34b

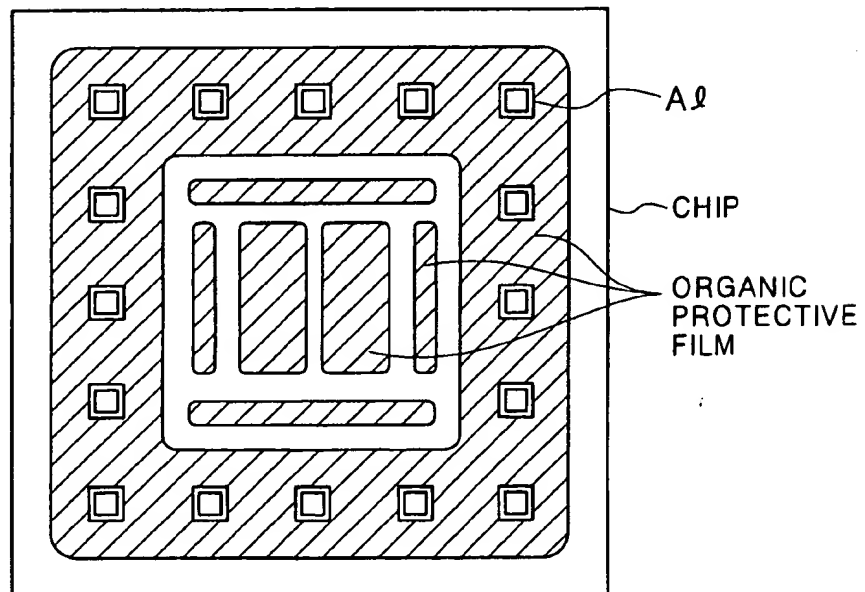
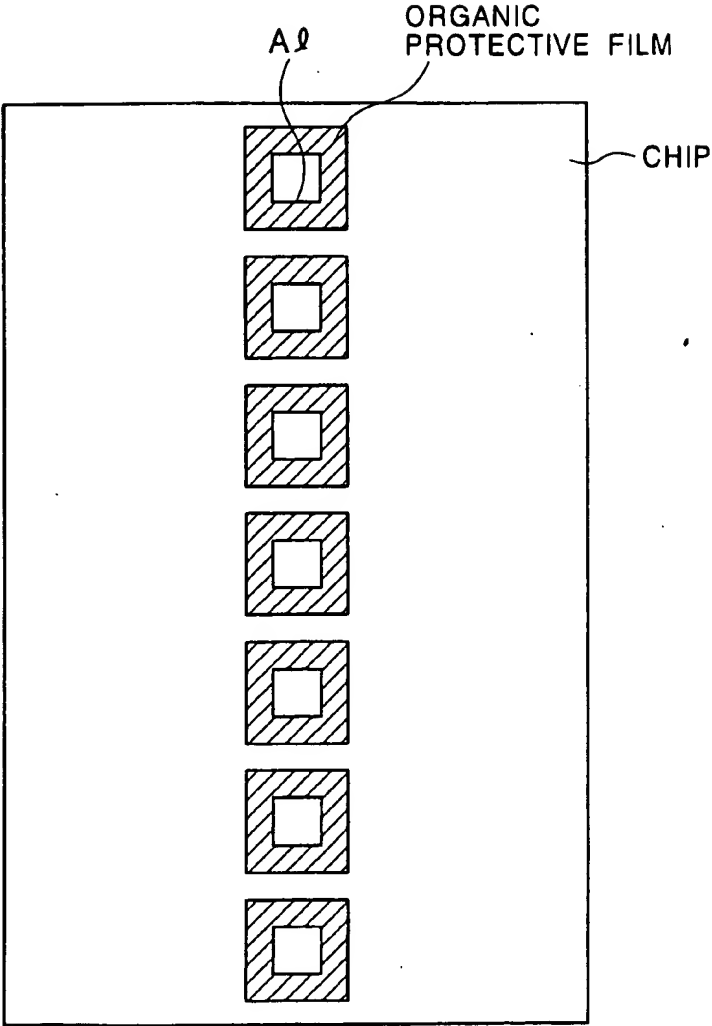


FIG. 35



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FIG. 36

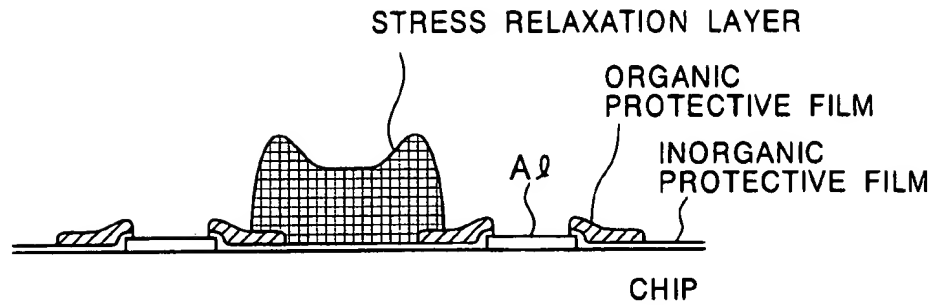
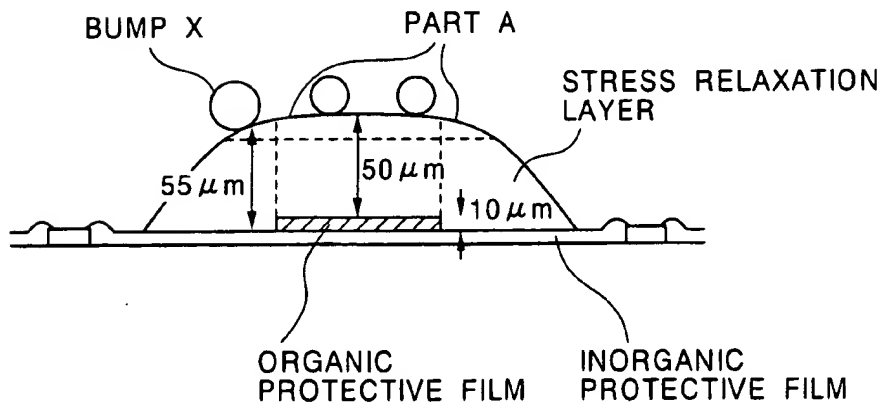


FIG. 37



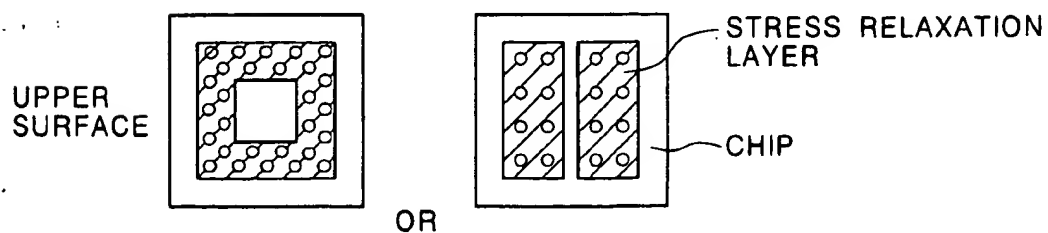
[illegible]

FIG. 40

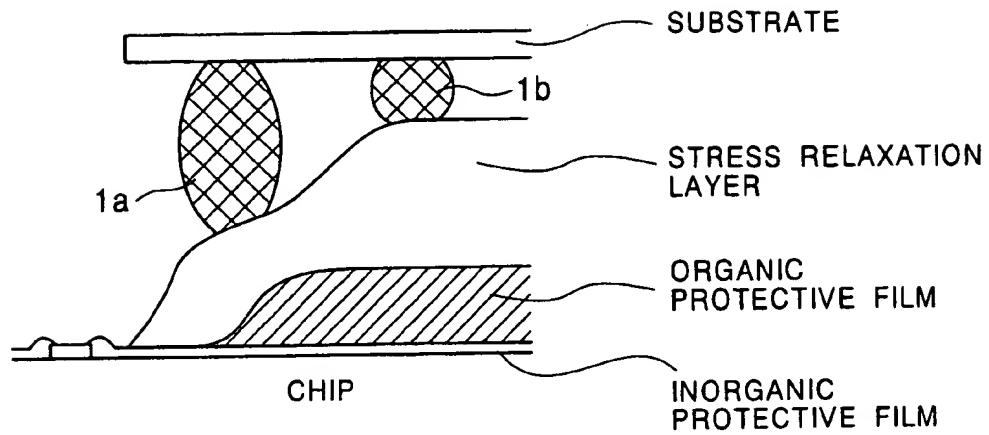
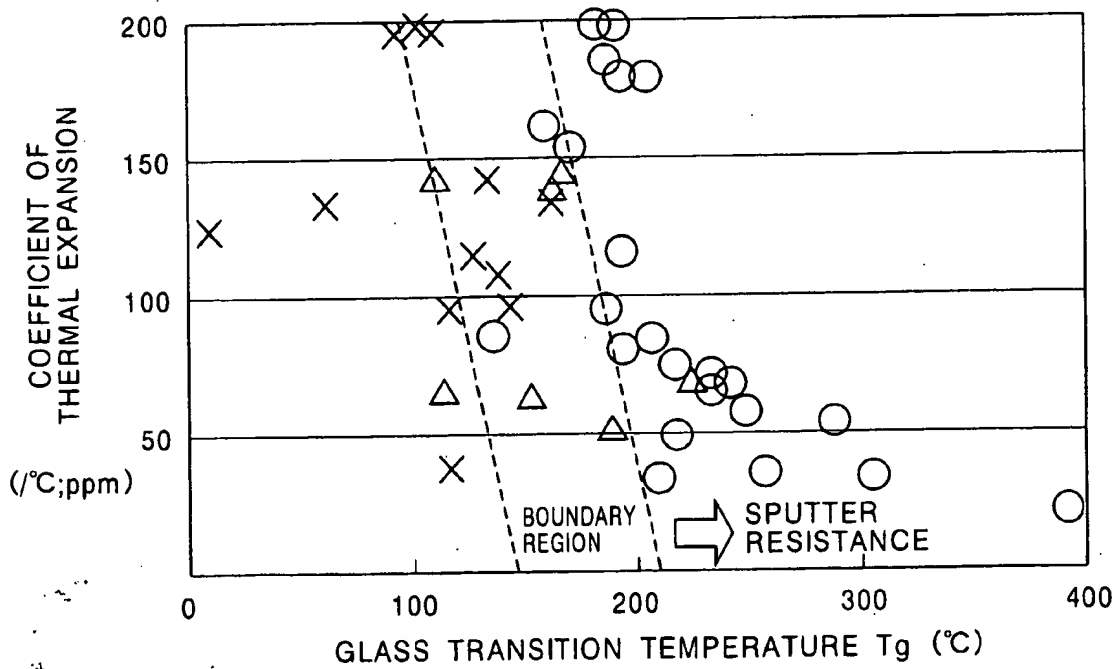


FIG. 41



PHYSICAL VALUES AND SPUTTER RESISTANCE OF STRESS RELAXATION LAYER CANDIDATE MATERIAL
(X: OCCURRENCE OF CRACKS, Δ : OCCURRENCE OF WRINKLE, \circ : NO ABNORMALITY)